SDAS192B - APRIL 1982 - REVISED DECEMBER 1994

 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

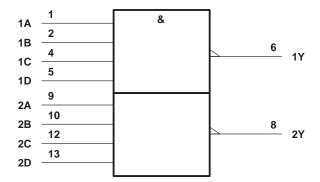
These devices contain two independent 4-input positive-NAND gates. They perform the Boolean functions $Y = \overline{A} \cdot \overline{B} \cdot \overline{C} \cdot \overline{D}$ or $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$ in positive logic.

The SN54ALS20A and SN54AS20 are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS20A and SN74AS20 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE
(each gate)

	INP	UTS	OUTPUT	
Α	В	С	D	Y
Н	Н	Н	Н	L
L	Х	Х	Х	н
Х	L	Х	Х	н
Х	Х	L	Х	н
Х	Х	Х	L	н

logic symbol[†]



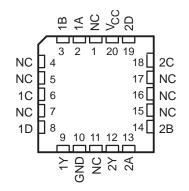
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

SN54ALS20A, SN54AS20 J PACKAGE
SN74ALS20A, SN74AS20 D OR N PACKAGE
(TOP VIEW)

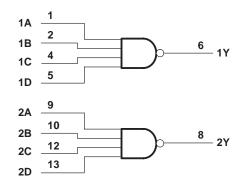
	_		
1A		\bigcup_{14}	V _{CC} 2D
1B		13	2D
NC	3	12	2C
1C	4	11] NC
1D	5	10] 2B
1Y	6	9	2A
GND	7	8] 2Y

SN54ALS20A, SN54AS20...FK PACKAGE (TOP VIEW)



NC – No internal connection

logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}		
Input voltage, V ₁		7 V
Operating free-air temperature range, TA: S	SN54ALS20A	–55°C to 125°C
S	SN74ALS20A	0°C to 70°C
Storage temperature range		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	SN54ALS20A		SN74ALS20A			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
	Low-level input voltage			0.8‡			0.8	
VIL				0.7§				V
IOH	High-level output current			-0.4			-0.4	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C
1		-						

[‡] Applies over temperature range – 55°C to 70°C

§ Applies over temperature range 70°C to 125°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN	54ALS2)A	SN	74ALS2	DA	
PARAMETER	TEST C	TEST CONDITIONS		TYP¶	MAX	MIN	TYP¶	MAX	UNIT
VIK	$V_{CC} = 4.5 V,$	lı = -18 mA			-1.5			-1.5	V
VOH	V_{CC} = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		V
Max		$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	
VOL	V _{CC} = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
lj	$V_{CC} = 5.5 V,$	V _I = 7 V			0.1			0.1	mA
Чн	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
١ _{١L}	$V_{CC} = 5.5 V,$	$V_{I} = 0.4 V$			-0.1			-0.1	mA
۱ ₀ #	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
Іссн	V _{CC} = 5.5 V,	$V_{I} = 0$		0.22	0.4		0.22	0.4	mA
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		0.81	1.5		0.81	1.5	mA

¶ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL RL	C = 4.5 = 50 pF = 500 Ω = MIN t		UNIT	
			SN54A	LS20A	SN74A	LS20A	
			MIN	MAX	MIN	MAX	
^t PLH		v	1	12.5	3	11	
^t PHL	A, B, C, or D	t t	1	11	3	10	ns

⁺ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Operating free-air temperature range, T _A : SN54AS20	
SN74AS20	0°C to 70°C
Storage temperature range	. −65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS20			S	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEAT A		SI	SN54AS20			SN74AS20			
PARAMETER	TESTC	ONDITIONS	MIN	TYP§	MAX	MIN	TYP§	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	V	
VOH	V _{CC} = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V _{CC} -2			V _{CC} -2	2		V	
VOL	$V_{CC} = 4.5 V,$	I _{OL} = 20 mA		0.35	0.5		0.35	0.5	V	
lı	V _{CC} = 5.5 V,	$V_{I} = 7 V$			0.1			0.1	mA	
ЧН	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20			20	μΑ	
١ _{١L}	V _{CC} = 5.5 V,	$V_{ } = 0.4 V$			-0.5			-0.5	mA	
۱ ₀ ¶	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA	
Іссн	V _{CC} = 5.5 V,	$V_{I} = 0$		1	1.6		1	1.6	mA	
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		5.4	8.7		5.4	8.7	mA	

§ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SDAS192B - APRIL 1982 - REVISED DECEMBER 1994

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то (оитрит)	CL RL TA	$V_{CC} = 4.5 V to 5.5 V$ $C_L = 50 pF$, $R_L = 500 Ω$, $T_A = MIN to MAX^{\dagger}$ SN54AS20 SN74A3			UNIT
			MIN	MAX	MIN	MAX	
tPLH	A, B, C, or D	V	1	5.5	1	5	ns
^t PHL	A, B, C, OI D		1	5	1	4.5	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES 7 V $R_1 = R1 = R2$ Vcc Ć **S1** RL **R1** Test **From Output From Output** Test Test From Output **Under Test** Point **Under Test** Point **Under Test** Point CL R_L CL \geq **R2** CL (see Note A) (see Note A) (see Note A) LOAD CIRCUIT FOR **BI-STATE** LOAD CIRCUIT LOAD CIRCUIT FOR OPEN-COLLECTOR OUTPUTS FOR 3-STATE OUTPUTS **TOTEM-POLE OUTPUTS** 3.5 V 3.5 V Timing **High-Level** 1.3 V 1.3 V 1.3 V Input Pulse 0.3 V 0.3 V th tsu 3.5 V 3.5 V Data Low-Level 1.3 V 1.3 V v 1.3 V Input Pulse 0.3 V 0.3 V **VOLTAGE WAVEFORMS** VOLTAGE WAVEFORMS SETUP AND HOLD TIMES PULSE DURATIONS 3.5 V Output Control 1.3 V 1.3 V (low-level 0.3 V enabling) 3.5 V ^tPZL Input 1.3 V 1.3 V ^tPLZ 0.3 V 3.5 V ^tPHL Waveform 1 ^tPLH 1.3 V S1 Closed VOH In-Phase (see Note B) 1.3 V 1.3 V Vol Output VOL 0.3 V ^tPHZ ^tPLH ^tPZH ^tPHL VOH VOH Waveform 2 Out-of-Phase 1.3 V S1 Open 1.3 V 0.3 V 1.3 V Output (see Note B) VOL (see Note C) ≈0 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8858901DA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8858901DA SNJ54ALS20AW	Samples
JM38510/37003BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 37003BCA	Samples
M38510/37003BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 37003BCA	Samples
SN74ALS20AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS20A	Samples
SN74ALS20ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS20A	Samples
SN74ALS20AN	ACTIVE	PDIP	Ν	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS20AN	Samples
SN74ALS20ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS20A	Samples
SN74AS20D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS20	Samples
SN74AS20N	ACTIVE	PDIP	Ν	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS20N	Samples
SNJ54ALS20AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54ALS 20AFK	Samples
SNJ54ALS20AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54ALS20AJ	Samples
SNJ54ALS20AW	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8858901DA SNJ54ALS20AW	Samples
SNJ54AS20J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54AS20J	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



6-Feb-2020

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS20A, SN54AS20, SN74ALS20A, SN74AS20 :

- Catalog: SN74ALS20A, SN74AS20
- Military: SN54ALS20A, SN54AS20

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	Il dimensions are nominal												
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74ALS20ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74ALS20ANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TEXAS INSTRUMENTS

www.ti.com

PACKAGE MATERIALS INFORMATION

10-Aug-2016



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS20ADR	SOIC	D	14	2500	367.0	367.0	38.0
SN74ALS20ANSR	SO	NS	14	2000	367.0	367.0	38.0

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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